

# MD1803DFX

High voltage NPN Power transistor for standard definition CRT display

## Features

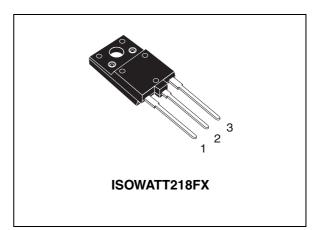
- State-of-the-art technology:
  - Diffused collector "enhanced generation"
- More stable performance versus operating temperature variation
- Low base drive requirement
- Tighter h<sub>FE</sub> range at operating collector current
- Fully insulated power package U.L. compliant
- Integrated free wheeling diode
- In compliance with the 2002/93/EC european directive

## Applications

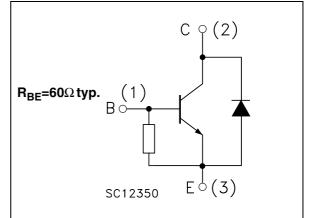
Horizontal deflection output for TV

## Description

The MD1803DFX is manufactured using Diffused Collector in Planar Technology adopting new and enhanced high voltage structure. The new MD product series show improved silicon efficiency bringing updated performance to the Horizontal Deflection stage.



## Internal schematic diagram



### **Order codes**

Part number	Marking	Package	Packing
MD1803DFX	MD1803DFX	ISOWATT218FX	TUBE

Septer	nber	2006
000.00		

www.st.com

# ww1DataSheeElectrical ratings

	Absolute maximum rating						
Symbol	Parameter	Value	Unit				
$V_{CES}$	Collector-emitter voltage (V <sub>BE</sub> = 0)	1500	V				
V <sub>CEO</sub>	Collector-emitter voltage $(I_B = 0)$	700	V				
$V_{\text{EBO}}$	Emitter-base voltage ( $I_C = 0$ )	10	V				
I <sub>C</sub> Collector current		10	Α				
I <sub>CM</sub>	Collector peak current (t <sub>P</sub> < 5ms)	15	Α				
Ι <sub>Β</sub>	Base current	5	Α				
P <sub>TOT</sub>	Total dissipation at $T_c = 25^{\circ}C$	57	W				
V <sub>isol</sub>	Insulation withstand voltage (rms) from all three leads to external heatsink	2500	V				
T <sub>stg</sub>	Storage temperature	-65 to 150	°C				
Τ <sub>J</sub>	Max. operating junction temperature	150					

### Table 1. Absolute maximum rating

### Table 2. Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case Max	2.2	°C/W



## 2 Electrical characteristics

(T<sub>CASE</sub> = 25°C; unless otherwise specified)

Symbol	Parameter	Test cor	nditions	Min.	Тур.	Max.	Unit
I <sub>CES</sub>	Collector cut-off current (V <sub>BE</sub> = 0)	V <sub>CE</sub> = 1500V V <sub>CE</sub> = 1500V	T <sub>c</sub> = 125°C			0.2 2	mA mA
I <sub>EBO</sub>	Emitter cut-off current $(I_{\rm C}=0)$	V <sub>EB</sub> = 5V		40		120	mA
V <sub>(BR)EBO</sub>	Emitter-base breakdown voltage $(I_{\rm C}=0)$	I <sub>E</sub> = 700 mA		10			V
V <sub>CE(sat)</sub> Note 1	Collector-emitter saturation voltage	I <sub>C</sub> = 5 A	l <sub>B</sub> = 1.25 A			2	V
V <sub>BE(sat)</sub> Note 1	Base-emitter saturation voltage	I <sub>C</sub> = 5 A	I <sub>B</sub> = 1.25 A			1.2	v
h		I <sub>C</sub> = 1 A	$V_{CE} = 5 V$		18		
h <sub>FE</sub> Note 1	DC current gain	I <sub>C</sub> = 5 A	$V_{CE} = 1 V$		5		
Note 1		I <sub>C</sub> = 5 A	$V_{CE} = 5 V$	5.5		7.5	
V <sub>f</sub>	Diode forward voltage	I <sub>F</sub> = 5 A				1.6	V
	Inductive load	$I_{\rm C} = 4 {\rm A}$	f <sub>h</sub> = 16KHz				
t <sub>s</sub>	Storage time	$I_{B(on)} = 0.6A$	$V_{BE(off)} = -2.7V$		2.5	3	μs
t <sub>f</sub>	Fall time	$L_{BB(off)} = 4.5 \mu H$			0.3	0.6	μs

#### Table 3. Electrical characteristics

1 Pulsed duration = 300  $\mu$ s, duty cycle  $\leq$ 1.5%.

57

#### **Electrical characteristics (curve)** 2.1

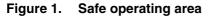
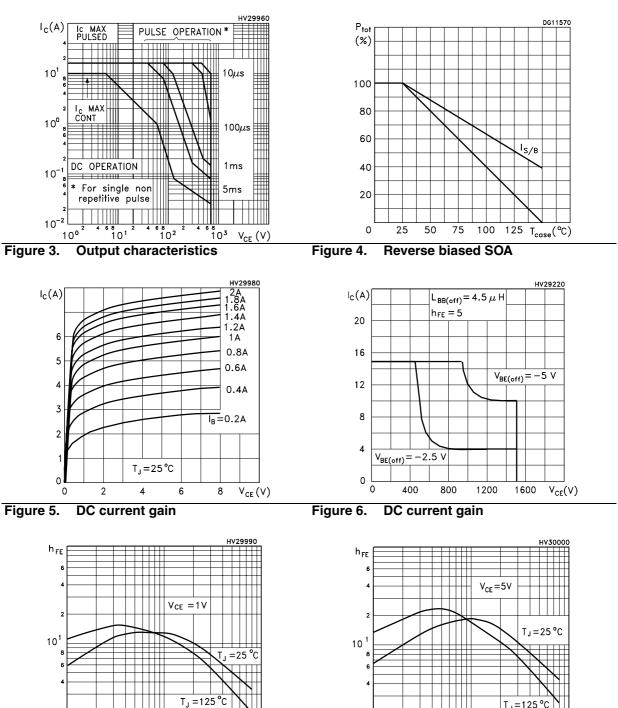


Figure 2. **Derating curve** 



2

10<sup>-1</sup>

2

6

°10°

4

10<sup>0</sup>

'n

٥<sub>c</sub>(A)

<sup>6</sup> <sup>8</sup> 10<sup>0</sup>

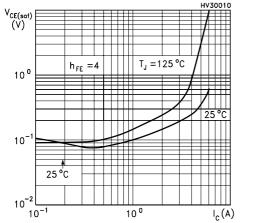
T<sub>J</sub>=125 °C

4

<sup>6</sup> ا<sub>د</sub> (A)

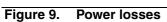
10<sup>0</sup>

10<sup>-1</sup>



### Figure 7. Collector-emitter saturation voltage Figure 8. Base-emitter saturation voltage

V<sub>BE (sat)</sub> (V)



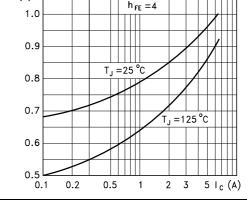
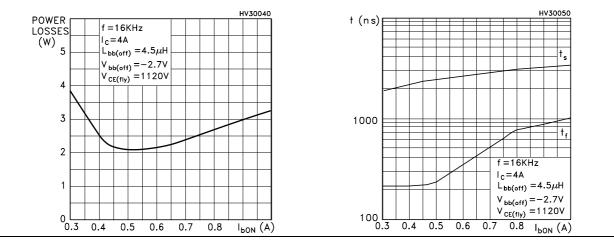
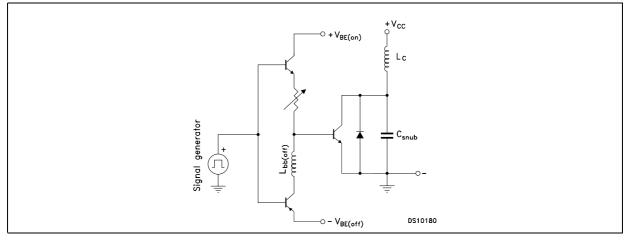


Figure 10. Inductive load switching time

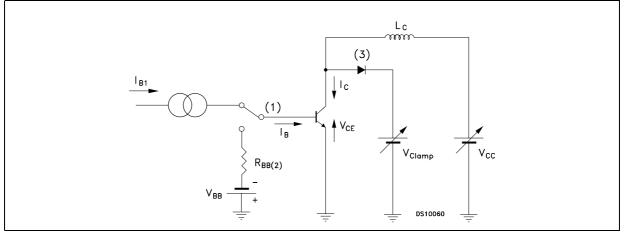


## 2.2 Test circuit



### Figure 11. Power losses and inductive load switching test circuit







## **3** Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



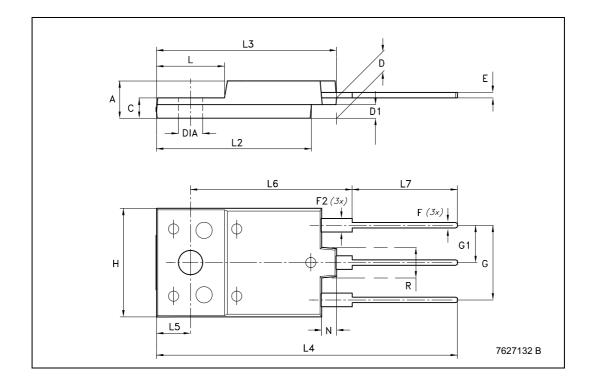
7/10

### Package mechanical data

www.DataSheet4U.com

#### **ISOWATT218FX MECHANICAL DATA**

DIM.	mm.				
DIN.	MIN.	ТҮР	MAX.		
A	5.30		5.70		
С	2.80		3.20		
D	3.10		3.50		
D1	1.80		2.20		
E	0.80		1.10		
F	0.65		0.95		
F2	1.80		2.20		
G	10.30		11.50		
G1		5.45			
Н	15.30		15.70		
L	9		10.20		
L2	22.80		23.20		
L3	26.30		26.70		
L4	43.20		44.40		
L5	4.30		4.70		
L6	24.30		24.70		
L7	14.60		15		
N	1.80		2.20		
R	3.80		4.20		
Dia	3.40		3.80		





# **Revision history**

Date	Revision	Changes
18-Oct-2005	1	First release
11-Nov-2005	2	New Template, no content change
15-Feb-2006	3	Complete version with curves
08-May-2006	4	Typo mistake on table1
23-May-2006	5	V <sub>(BR)EBO</sub> value has been changed
22-Sep-2006	6	New h <sub>FE</sub> limit

### Table 4. Revision history



www.DataSheet4U.com

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

#### © 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com